

# P-Channel 30-V (D-S) MOSFET

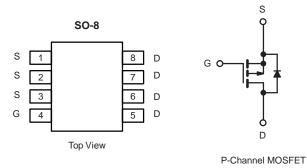
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<sub>DS</sub> (V) R <sub>DS(on)</sub> (Ω)		Q <sub>g</sub> (Typ.)			
- 30	0.011 at V <sub>GS</sub> = - 10 V	- 11.6	22 nC			
- 30	0.012 at $V_{GS}$ = - 4.5 V	- 10	22110			



- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested

#### **APPLICATIONS**

- Load Switches
  - Notebook PCs
  - Desktop PCs



Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 30	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		- 11.6		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 10.5		
Continuous Drain Current $(1_j = 150 \text{ C})$	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 8.7 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 7.7 <sup>a, b</sup>		
Pulsed Drain Current	I <sub>DM</sub>	- 40	— A		
Continuous Course Durin Diada Current	T <sub>C</sub> = 25 °C	1	- 4.6		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.0 <sup>a, b</sup>		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 20		
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		5.6		
Maximum Dawar Dissinction	T <sub>C</sub> = 70 °C		3.6	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	VV	
	T <sub>A</sub> = 70 °C	1 -	1.6 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	39	50	°C/W	
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	18	22	0/10	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 85 °C/W. d. Based on  $T_C = 25$  °C.



HALOGEN

FREE Available

				W	ww.VBse	mi.com
		nuine meteri				
<b>SPECIFICATIONS</b> $T_J = 25 \circ C$				1	1	1
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						1
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 31		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	5 .		5.5		11107 0
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 3.0	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			± 100	nA
Zara Cata Valtaga Drain Current	1	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	۸
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 5	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ - 10 V, $V_{GS}$ = - 10 V	- 30			А
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10 A		0.011		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 7 A		0.012		Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 10 A		23		S
Dynamic <sup>b</sup>				1		1
Input Capacitance	C <sub>iss</sub>			1960		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		380		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			325		
		V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10 A		43	65	
Total Gate Charge	Qg			22	33	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 10 A		6		nC
Gate-Drain Charge	Q <sub>gd</sub>			11		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.3	1.3	2.5	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			11	22	
Rise Time	t <sub>r</sub>	$V_{DD} = -15 V, R_1 = 3 \Omega$		13	25	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -5 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		32	50	-
Fall Time	t <sub>f</sub>			9	18	
Turn-On Delay Time	t <sub>d(on)</sub>			44	70	ns
Rise Time	t <sub>r</sub>	$V_{DD} = -15 V, R_1 = 3 \Omega$		100	160	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 5 A, $V_{GEN}$ = - 4.5 V, $R_a$ = 1 $\Omega$		28	50	
Fall Time	t <sub>f</sub>			15	30	
Drain-Source Body Diode Characteris						1
Continuous Source Drain Diade Current	-	T 25 %C		1	4.6	

Drain-Source Body Diode Characterist	ics				
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C		- 4.6	٨
Pulse Diode Forward Current	I <sub>SM</sub>			- 50	~
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 2 A, V <sub>GS</sub> = 0 V	- 0.75	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>		28	45	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>E</sub> = - 2 A, dl/dt = 100 A/μs, T <sub>1</sub> = 25 °C	20	40	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$F_{\rm F} = -2$ A, $di/dt = 100$ A/µs, $T_{\rm J} = 25$ C	13		ns
Reverse Recovery Rise Time	t <sub>b</sub>	]	15		115

Notes:

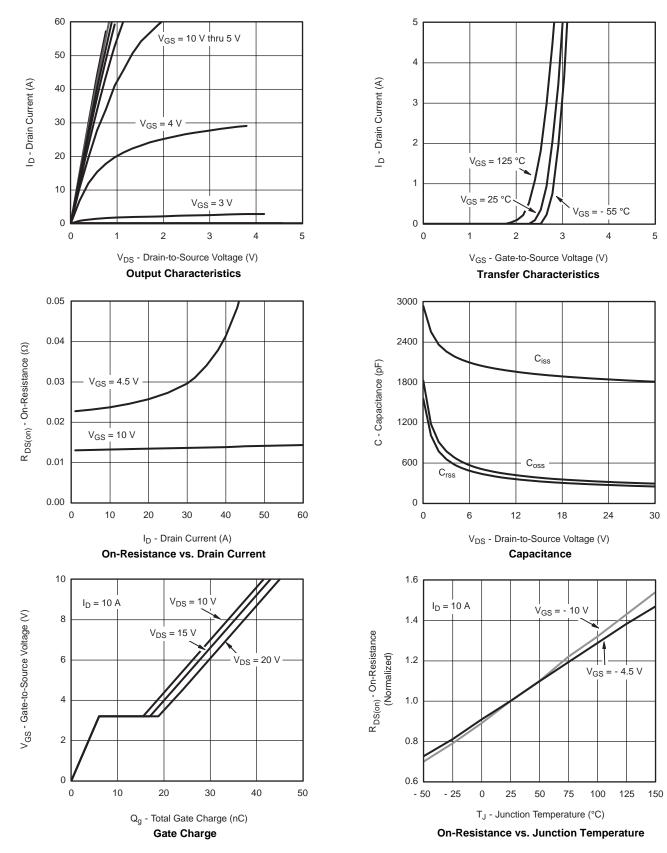
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

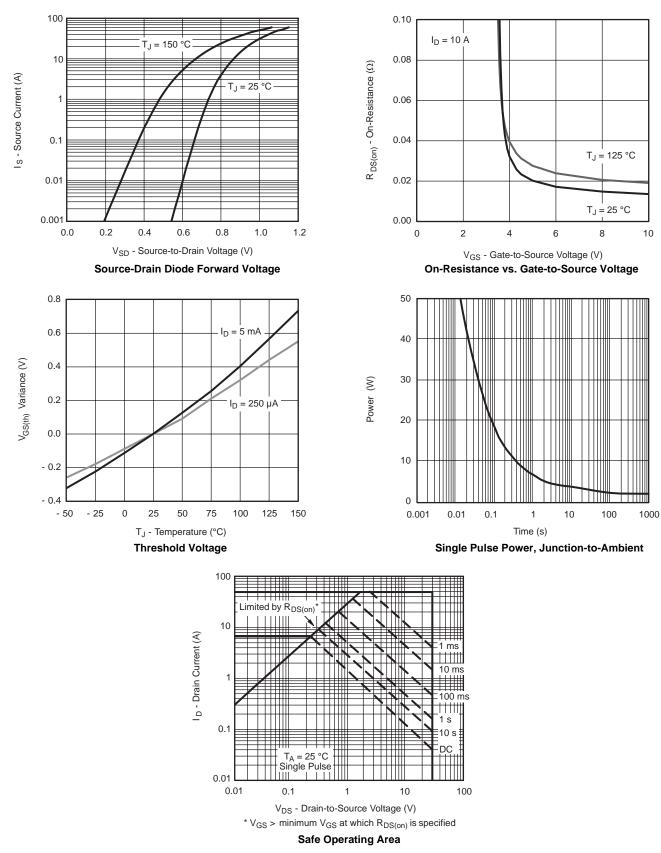
Bsemi



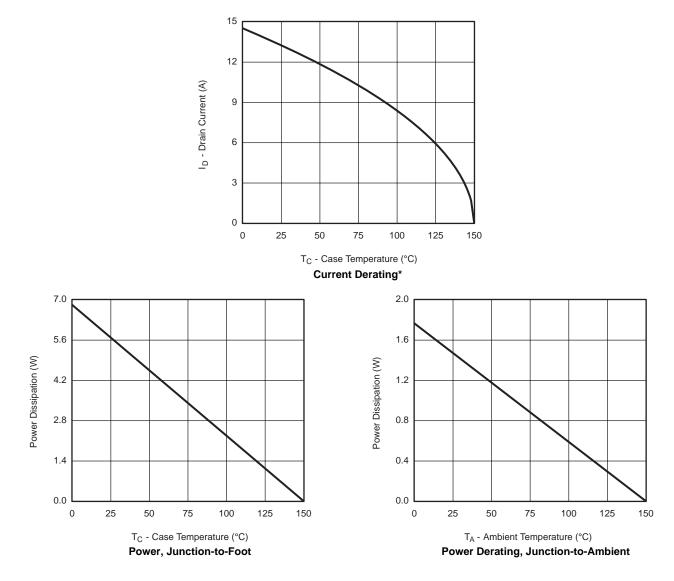


服务热线:400-655-8788



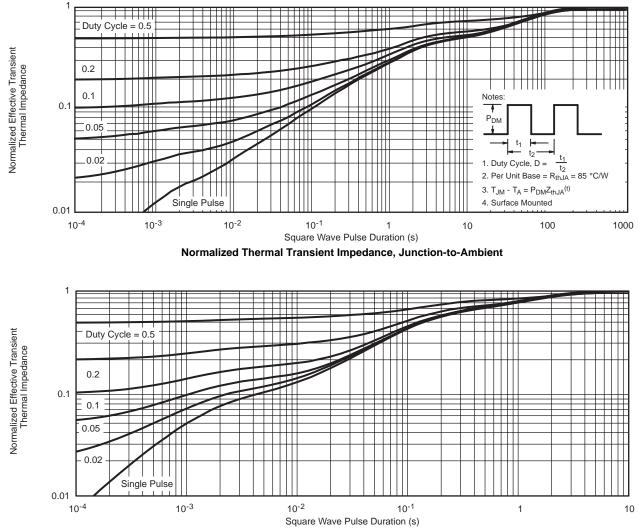






\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



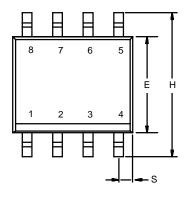


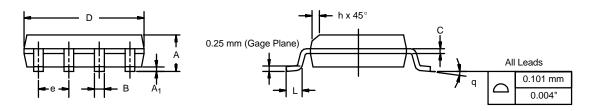
Normalized Thermal Transient Impedance, Junction-to-Foot



## SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

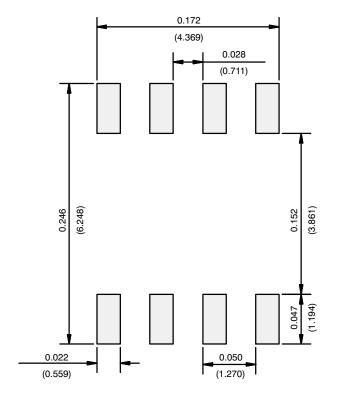




	MILLIM	IETERS	INC	HES	
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
e	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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